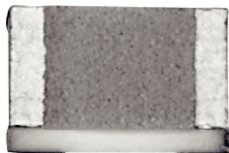


High Stability - High Temperature (230 °C) Thin Film Wraparound Chip Resistors



INTRODUCTION

For applications such as down hole applications, the need for parts able to withstand very severe conditions (temperature as high as 215 °C powered or up to 230 °C un-powered) has led Vishay Sfernice to push out the limit of the thin film technology.

Designers might read the application note: Power Dissipation Considerations in High Precision Vishay Sfernice Thin Film Chip Resistors and Arrays (P, PRA etc...) (High Temperature Application) www.vishay.com/doc?53047 in conjunction with this datasheet to help them to properly design their PCBs and get the best performances of the PHT.

Vishay Sfernice R&D engineers will be willing to support any customer design considerations.

FEATURES

- Operating temperature range: - 55 °C; + 215 °C
- Storage temperature: - 55 °C; + 230 °C
- Gold terminations (< 1 µm thick)
- 5 sizes available (0402, 0603, 0805, 1206, 2010); other sizes upon request
- Temperature coefficient down to 15 ppm (- 55 °C; + 215 °C)
- Tolerance down to 0.05 %
- Load life stability: 0.35 % max. after 2000 h at 220 °C (ambient) at Pn
- Shelf life stability: 0.7 % typ. (1 % max.) after 15 000 h at 230 °C
- SMD wraparound
- 0.02 % upon request
- TCR remains constant after long term storage at 230 °C (15 000 h)
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
GREEN
(5-2008)

STANDARD ELECTRICAL SPECIFICATIONS

MODEL	SIZE	RESISTANCE RANGE Ω	RATED POWER ⁽¹⁾⁽²⁾ P _{215 °C} W	LIMITING ELEMENT VOLTAGE V	TOLERANCE ± %	TEMPERATURE COEFFICIENT ⁽³⁾ ± ppm/°C
PHT0402	0402	10 to 150K	0.0189	50	0.05, 0.1, 0.5, 1	10, 15, 25, 30, 50, 55
PHT0603	0603	10 to 500K	0.0375	75	0.05, 0.1, 0.5, 1	10, 15, 25, 30, 50, 55
PHT0805	0805	10 to 750K	0.06	150	0.05, 0.1, 0.5, 1	10, 15, 25, 30, 50, 55
PHT1206	1206	10 to 3.5M	0.1	200	0.05, 0.1, 0.5, 1	10, 15, 25, 30, 50, 55
PHT2010	2010	10 to 7.5M	0.2 ⁽⁴⁾	300	0.05, 0.1, 0.5, 1	10, 15, 25, 30, 50, 55

Notes

- (1) For power handling improvement, please refer to application note 53047: Power Dissipation Considerations in High Precision Vishay Sfernice Thin Film Chip Resistors and Arrays (High Temperature Applications) www.vishay.com/doc?53047 and consult Vishay Sfernice
- (2) See Table 2 on next page
- (3) See Table 1 on next page
- (4) It is possible to dissipate up to 0.3 W, but there will be an additional drift of 0.1 % after load life

CLIMATIC SPECIFICATIONS

Operating temperature range	- 55 °C; + 215 °C
Storage temperature range	- 55 °C; + 230 °C

MECHANICAL SPECIFICATIONS

Substrate	Alumina
Resistive Element	Nichrome (NiCr)
Passivation	Silicon nitride (Si ₃ N ₄)
Protection	Epoxy + Silicone
Terminations	Gold (< 1 µm) over nickel barrier

Note

- For other terminations, please consult



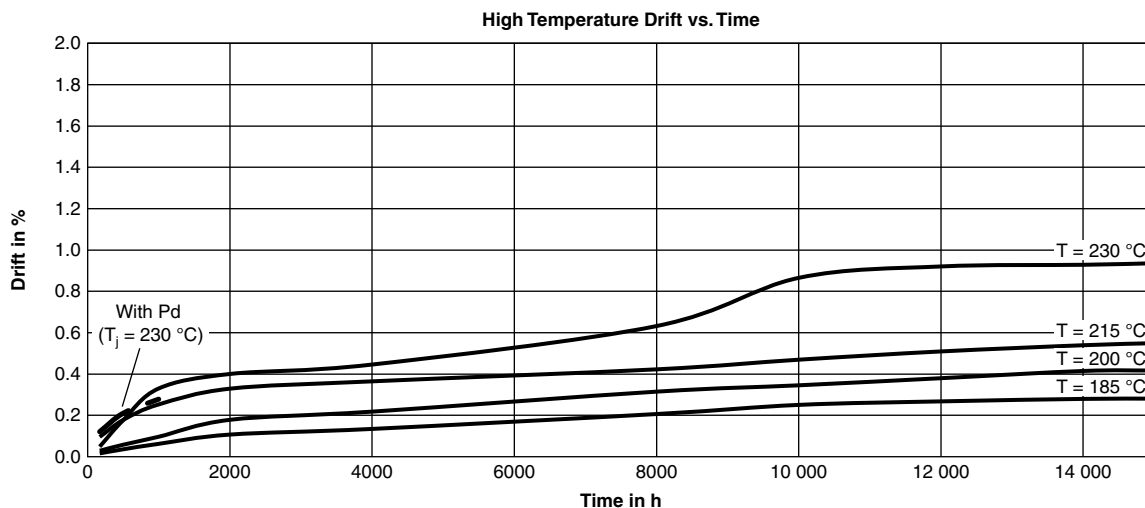
TABLE 1 - TEMPERATURE COEFFICIENT

Y	10 ppm/°C	- 55 °C; + 155 °C
	15 ppm/°C	- 55 °C; + 215 °C
E	25 ppm/°C	- 55 °C; + 155 °C
	30 ppm/°C	- 55 °C; + 215 °C
H	50 ppm/°C	- 55 °C; + 155 °C
	55 ppm/°C	- 55 °C; + 215 °C

TABLE 2

SERIES	RANGE (Ω)	TOL. (± %)	TCR CODE
0402	From 10R to 90K	0.05; 0.1; 0.5; 1	Y; E; H
	From > 90K to 130K	0.05; 0.1; 0.5; 1	E; H
0603	From 10R to 210K	0.05; 0.1; 0.5; 1	Y; E; H
	From > 210K to 320K	0.05; 0.1; 0.5; 1	E; H
0805	From 10R to 480K	0.05; 0.1; 0.5; 1	Y; E; H
	From > 480K to 720K	0.05; 0.1; 0.5; 1	E; H
1206	From 10R to 1M8	0.05; 0.1; 0.5; 1	Y; E; H
	From > 1M8 to 2M7	0.05; 0.1; 0.5; 1	E; H
2010	From 10R to 5M	0.05; 0.1; 0.5; 1	Y; E; H
	From > 5M to 7M5	0.05; 0.1; 0.5; 1	E; H

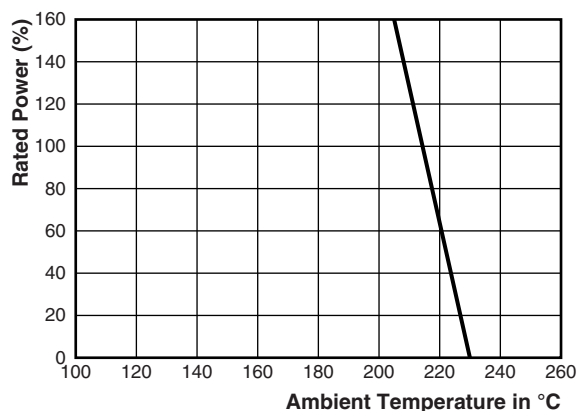
PHT STABILITY CURVE

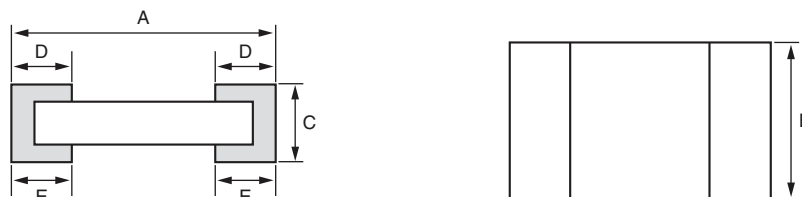


Note

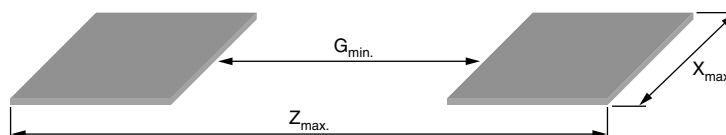
- Stability will be dependent on resistivity of resistor. Above curves are worst case.

POWER DERATING CURVE



DIMENSIONS in millimeters (inches)


CASE SIZE	A	B	C	D/E	
	MAX. TOL. + 0.152 (+ 0.006) MIN. TOL. - 0.152 (- 0.006)	MAX. TOL. + 0.127 (+ 0.005) MIN. TOL. - 0.127 (- 0.005)			
	NOMINAL	NOMINAL		NOMINAL	NOMINAL
0402	1.00 (0.039)	0.60 (0.024)	0.5 (0.02) ± 0.127 (0.005)	0.25 (0.010)	0.1 (0.004)
0603	1.52 (0.060)	0.85 (0.033)		0.38 (0.015)	0.13 (0.005)
0805	1.91 (0.075)	1.27 (0.050)		0.40 (0.016)	
1206	3.06 (0.120)	1.60 (0.063)		0.48 (0.019)	
2010	5.08 (0.200)	2.54 (0.100)			

SUGGESTED LAND PATTERN (TO IPC-7351A)


CHIP SIZE	DIMENSIONS (in millimeter)		
	Z _{max.}	G _{min.}	X _{max.}
0402	1.55	0.15	0.73
0603	2.37	0.35	0.98
0805	2.76	0.74	1.40
1206	3.91	1.85	1.73
2010	5.93	3.71	2.67

Caution:

Performances obtained with following mounting conditions:

PCB: Polyimide

Solder paste: PbSnAg (93.5/5/1.5)

POPULAR OPTIONS

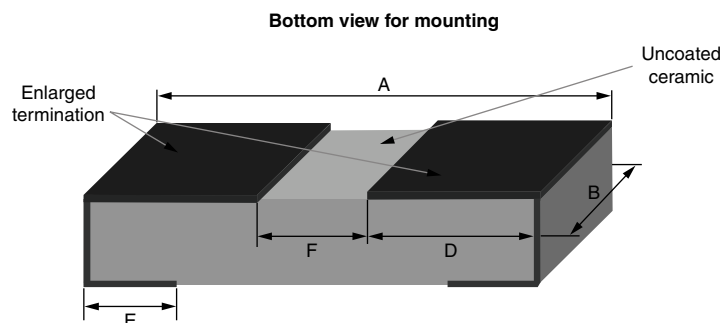
It is recommended to consult Vishay Sfernice for availability first.

Option: Enlarged terminations:

For stringent and special power dissipation requirements, the thermal resistance between the resistive layer and the solder joint can be reduced using enlarged terminations chip resistors which are soldered on large and thick copper pads acting as heatsink (see application note: 53048 Power Dissipation in High Precision Vishay Sfernice Chip Resistors and Arrays (P Thin Film, PRA Arrays, CHP Thick Film) www.vishay.com/doc?53048).

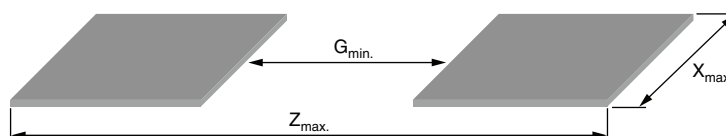
Option to order: 0063 (applies to size 1206/2010).

DIMENSIONS (Option 0063) in millimeters



CASE SIZE	A	B	E	D	F		
	MAX. TOL. + 0.152 MIN. TOL. - 0.152	MAX. TOL. + 0.127 MIN. TOL. - 0.127	MAX. TOL. + 0.13 MIN. TOL. - 0.13	MAX. TOL. + 0.13 MIN. TOL. - 0.13			
	NOMINAL	NOMINAL	NOMINAL	NOMINAL	NOMINAL	MIN.	MAX.
1206	3.06	1.60	0.40	1.215	0.63	0.50	0.76
2010	5.08	2.54	0.48	2.25			

SUGGESTED LAND PATTERN (Option 0063)



CHIP SIZE	DIMENSIONS (in millimeter)		
	Z _{max.}	G _{min.}	X _{max.}
1206	3.91	0.50	1.73
2010	5.93		2.67

**PACKAGING**

ESD packaging available: waffle-pack, and plastic tape and reel (low conductivity). Paper tape available upon request (ESD only).

SIZE	MOQ	NUMBER OF PIECES PER PACKAGE		TAPE WIDTH
		WAFFLE PACK 2" x 2"	TAPE AND REEL MIN. MAX.	
0402	100	100	100	5000
0603				
0805				
1206		140	100	4000
2010		60		2000
				8 mm (1)

Note

(1) 12 mm on request

PACKAGING RULES**Waffle Pack**

Can be filled up to maximum quantity indicated in the table here above, taking into account the minimum order quantity. When quantity ordered exceeds maximum quantity of a single waffle pack, the waffle packs are stacked up on the top of each other and closed by one single cover.

To get “not stacked up” waffle pack in case of ordered quantity > maximum number of pieces per package: Please consult Vishay Sfernice for specific ordering code.

Tape and Reel

Can be filled up to maximum quantity indicated in the table here above, taking into account the minimum order quantity. When quantity ordered is between the MOQ and the maximum reel capacity, only one reel is provided.

When several reels are needed for ordered quantity within MOQ and maximum reel capacity: Please consult Vishay Sfernice for specific ordering code.

GLOBAL PART NUMBER INFORMATION																	
Global Part Numbering: PHT1206Y1001BGT063																	
P	H	T	1	2	0	6	Y	1	0	0	1	B	G	T	0	6	3
GLOBAL MODEL		SIZE		TCR		VALUE		TOLERANCE		TERMINATION		PACKAGING		OPTION			
PHT		0402 0603 0805 1206 2010		Y E H		The first three digits are significant figures and the last digit specifies the number of zeros to follow, R designates decimal point 10R0 = 10 Ω 3901 = 3900 Ω 1004 = 1 MΩ		W = 0.05 % B = 0.1 % D = 0.5 % F = 1 %		G = Gold N = Tin/silver (2)		T = Tape and reel Blank = Waffle pack		Leave blank if no option			

Note

(2) For usage at temperatures up to 200 °C maximum N (tin/silver termination are available upon request)



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